

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appln. No: 10/583,105
Applicants: Nadarajah Narendran et al.
Filed: April 23, 2007
Title: High Efficiency Light Source Using Solid-State Emitter and Down-Conversion Material
TC/A.U.: 2875
Examiner: Sharon E. Payne

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Pursuant to 37 C.F.R. §§ 1.97 and 1.98 and to the duty of disclosure set forth in 37 C.F.R. § 1.56, the Examiner in charge of the above-identified application is requested to consider and make of record the references listed on the PTO/SB/08a form submitted herewith. A copy of each reference listed on the PTO/SB/08a, other than U.S. patents, is enclosed.

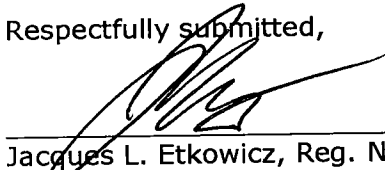
Although the information submitted herewith may be "material" to the Examiner's consideration of the subject application, this submission is not intended to constitute an admission that such information is "prior art" as to the claimed invention.

In accordance with 37 C.F.R. § 1.97(g), the filing of this Supplemental Information Disclosure Statement shall not be construed to mean that a search has been made.

Reference DE 3632743 A1 is not in the English language, but an English abstract thereof is attached to the copy of the reference submitted herewith.

This Supplemental Information Disclosure Statement is being filed before mailing of the first Official Action on the merits. No first Official Action on the merits has yet been received and it is presumed that none has yet been mailed. No fee or statement is required. 37 C.F.R. § 1.97(b).

Respectfully submitted,



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Enclosures: PTO/SB/08a
(1) Reference

Dated: September 3, 2008

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The Director is hereby authorized to charge or credit Deposit Account No. **18-0350** for any additional fees, or any underpayment or credit for overpayment in connection herewith.